

Material - Plating Mating	Tin
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	0.980/g
Number of Rows	2
Orientation	Vertical
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.60mm
Packaging Type	Tray
Pitch - Mating Interface	3.00mm
Plating min - Mating	0.254µm
Polarized to PCB	Yes
Shrouded	Fully
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-40° to +105°C
Termination Interface: Style	Through Hole - Kinked Pin
<b>Electrical</b>	
Current - Maximum per Contact	8.5A
Voltage - Maximum	600V
<b>Solder Process Data</b>	
Duration at Max. Process Temperature (seconds)	030
Lead-freeProcess Capability	SMC&WAVE
Max. Cycles at Max. Process Temperature	003
Process Temperature max. C	260
<b>Material Info</b>	
<b>Reference - Drawing Numbers</b>	
Packaging Specification	PK-70873-0314-001
Product Specification	430450001-PS-KO-000, 430450001-PS-SP-000, PS-43045-001
Sales Drawing	SD-43045-005-001
Symbol/Footprint Data	SYM-43045-0612-001, SYM-43045-061X-001
Test Summary	430450004-TS-000, TS-43045-001-001, TS-46235-001-001

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